

All-Plastic Lab-on-a-chip demonstration

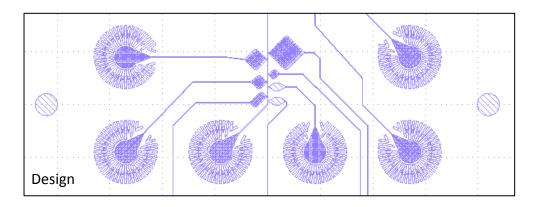
PolyNano event

-- Technical description --

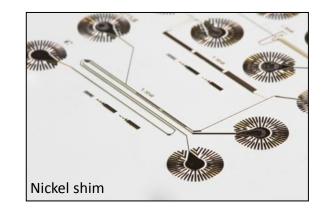


We are making all-plastic lab-on-a-chip using injection moulding.

- Nickel shims with the opposite polarity of the chip is used inside injection moulding cavity to create the chips
- Nickel shims can have line widths from sub-100 nm to hundreds of µm and the structures can have different heights
- Bonding of lids or sealing of channels are performed







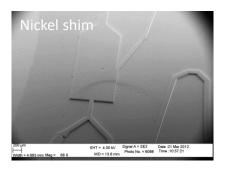
Key technologies:

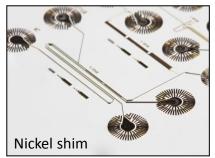
- Electron beam lithography
- DUV lithography
- UV lithography
- Dry etching (ICP, RIE, IBE)
- Nanoimprint lithography
- Hot-embossing
- Bonding (anodic, fusion, thermal, polymer)
- Nickel electroplating
- Injection molding

NICKEL SHIMS

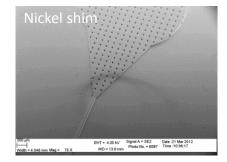


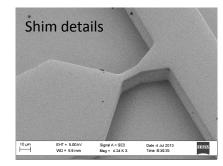
Nickel shims for LOC and microfluidics devices. **Nickel shims have the opposite polarity of the plastic chip.** The nickel shim are used for injection moulding or nanoimprint/hot embossing.

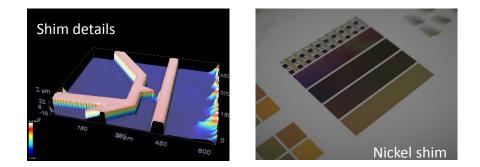




- The design can contain up to 3 lithography layers
- The minimum lateral dimensions on each layer is 60 nm made with EBL (electron beam lithography) layers and 3 µm made with UVL (UV lithography) layers
- The maximum aspect ratio on individual layers are 1:3 (width:height)
- Maximum height 125 μm
- Seed Layer: NiV
- Shim thickness 330 μ m +/-30 μ m



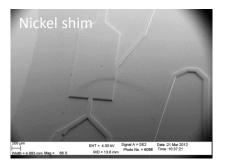


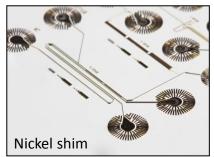


FORMATS AND INJECTION MOULDING



We are working with three different formats. You can download gds files at www.polynano.org/proofofconcept





Formats:

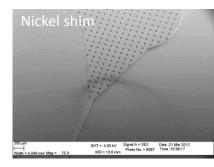
- Ø50 mm flat disc with thickness of 2 mm
- Ø50 mm disc with 12 Luer connectors and thickness of 2 mm
- Microscope slide of 21 mm x 76 mm and thickness of 1 mm

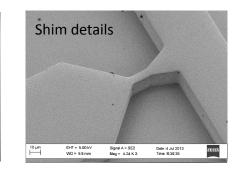
Polymers:

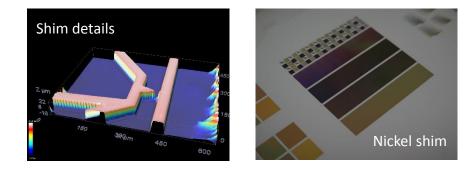
• Topas, PS, PP, PE, PC, PMMA

Lid/sealing of channels

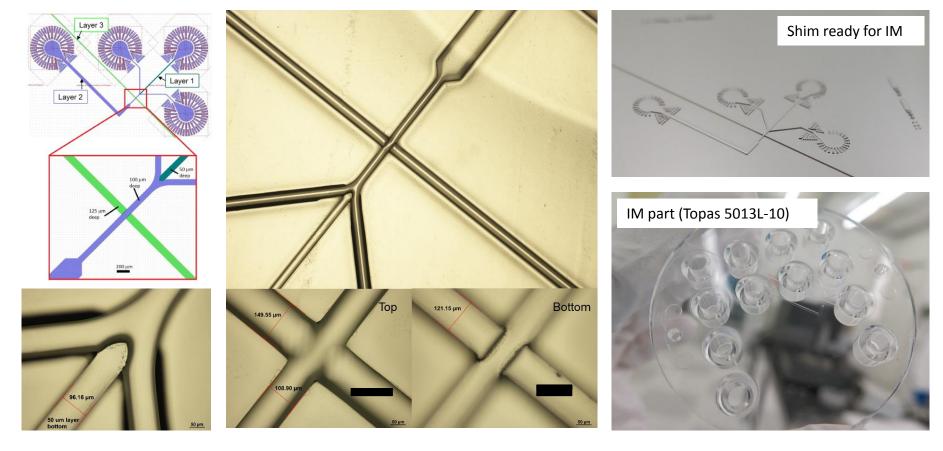
 Choice of technology depending on need





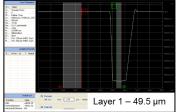


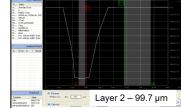
EXAMPLE: ALL-PLASTIC LAB-ON-A-CHIP BY INJECTION MOULDING

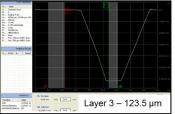


Lab-on-a-chip fabricated by injection moulding using nickel shim. Three layers.

Layer 1: 100 μ m wide and 50 μ m deep Layer 2: 100 μ m wide and 100 μ m deep Layer 3: 150 μ m wide and 125 μ m deep











PolyNano Partners









CONTACT INFORMATION



NIL Technology (NILT) is the responsible partner for making the lab-on-a-chip prototypes

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